

WG50N65DHJ1

Rev.01 - 28 February 2024

**IGBT** 

**Product data sheet** 

#### 1. General description

WG50N65DHJ1 uses advanced Fine Trench Field-stop IGBT technology with anti-parallel diode in TO3PF package to provide extremely low on state voltage, and minimal switching performance. This device is ideal for low switching frequency power conversion applications.



### 2. Features and benefits

- · Positive Temperature efficient for Easy Parallel Operating
- High Current Capability
- Low saturation Voltage  $V_{CE(Sat)}$  = 1.25 V(Typ.) @ I<sub>C</sub> = 50 A
- EMI Improved Design

### 3. Applications

- Solar Inverter
- UPS
- PFC
- Converters

## 4. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Parameter		Value			Unit
$V_{\text{CE}}$	Collector-emitter voltage, $T_j \ge 25 \text{ °C}$			650			V
I <sub>c</sub>	DC collector current, limited by $T_{j(max)}^{(1)}$ T <sub>c</sub> = 100 °C				50		A
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	racteristics						
$V_{\text{CE(sat)}}$	Collector-emitter saturation voltage	V <sub>GE</sub> = 15 V; I <sub>C</sub> = 50 A; T <sub>j</sub> = 25 °C		-	1.25	1.55	V

Note(1):  $I_{\rm C}$  and other electrical parameters definition follow TO247 package.

# 5. Pinning information

Table 2. Pi	nning infor	mation					
Pin	Symbol	Description	Simplified outline	Graphic symbol			
1	G	gate		۹C			
2	С	collector					
3	E	emitter					
mb	n.c.	mounting base; isolated		G E sym200			

# 6. Ordering information

Table 3. Ordering information								
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
WG50N65DHJ1	TO3PF	WG50N65DHJ1Q	Tube	30	SOT1293	16-Mar-2006		

### 7. Marking

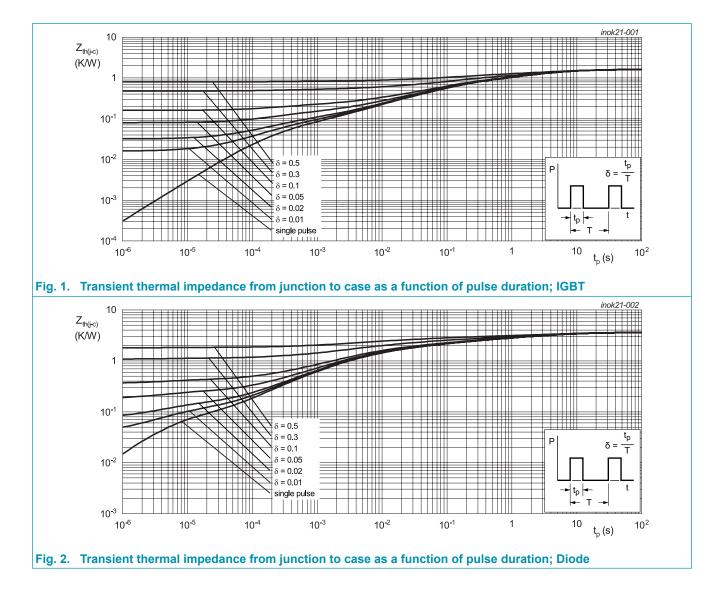
Table 4. Marking codes		
Type number	Marking codes	
WG50N65DHJ1	WG50N	
	65DHJ1	

# 8. Limiting values

Symbol	Parameter	Notes	Value	Unit
V <sub>CE</sub>	Collector-emitter voltage, $T_j \ge 25 \text{ °C}$		650	V
I <sub>c</sub>	DC collector current, limited by $T_{j(max)}$ T <sub>c</sub> = 25 °C T <sub>c</sub> = 100 °C		43 22	А
I <sub>C(puls)</sub>	Pulsed collector current, $t_p$ limited by $T_{j(max)}$		150	А
-	Turn off safe operating area $V_{CE} \le 600 \text{ V}, \text{ T}_{j} \le 150 \text{ °C}, \text{ t}_{p} = 1 \mu\text{s}$		150	A
I <sub>F</sub>	Diode forward current, limited by $T_{j(max)}$ T <sub>c</sub> = 25 °C T <sub>c</sub> = 100 °C		25 12	A
I <sub>Fpuls</sub>	Diode pulsed current, $t_p$ limited by $T_{j(max)}$		40	А
V <sub>GE</sub>	Gate-emitter voltage		±20	V
P <sub>tot</sub>	Power dissipation $T_c = 25 \degree C$ Power dissipation $T_c = 100 \degree C$		78 31	W
T <sub>stg</sub>	Storage temperature		-55 to 150	°C
T <sub>jmax</sub>	Maximum operating junction temperature		175	°C
_	Peak soldering temperture		260	°C
М	Mounting Torque with washer		0.55	Nm

# 9. Thermal characteristics

Table 6. Th	Table 6. Thermal characteristics							
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit	
R <sub>th(j-c)</sub>	IGBT thermal resistance from junction to case			-	1.6	-	K/W	
R <sub>th(j-c)</sub>	Diode thermal resistance from junction to case			-	3.6	-	K/W	
$R_{th(j-a)}$	thermal resistance from junction to ambient			-	40	-	K/W	



WG50N65DHJ1 Product data sheet

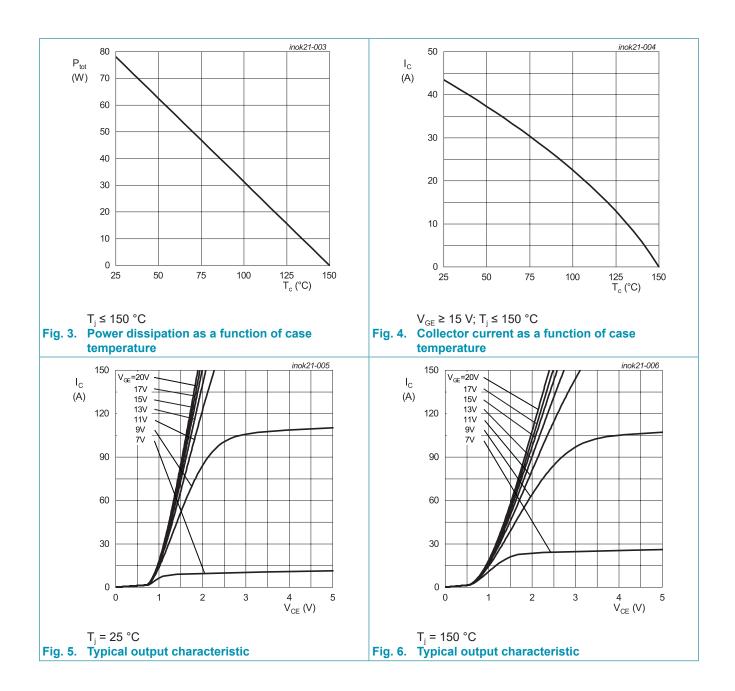
# **10. Characteristics**

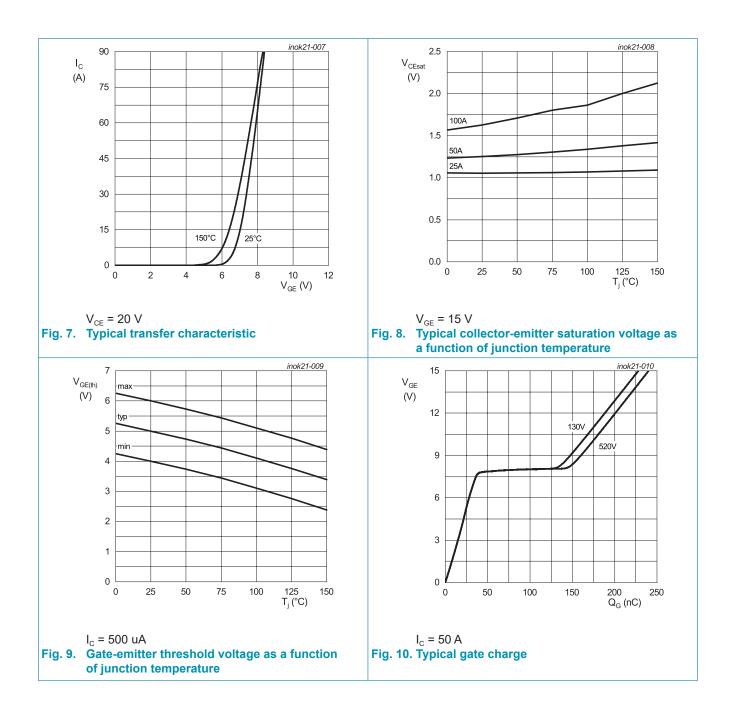
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	racteristics						
$BV_{CES}$	Collector-emitter breakdown voltage	$V_{GE}$ = 0 V; I <sub>C</sub> = 50 uA		650	-	-	V
- CE(sat)	Collector-emitter saturation	$V_{GE}$ = 15 V; I <sub>C</sub> = 50 A; T <sub>j</sub> = 25 °C		-	1.25	1.55	V
	voltage	$V_{GE}$ = 15 V; I <sub>C</sub> = 50 A; T <sub>j</sub> = 150 °C		-	1.5	-	V
V <sub>F</sub>	Diode forward voltage	$V_{GE}$ = 0 V; I <sub>F</sub> = 10 A; T <sub>j</sub> = 25 °C		-	1.8	-	V
		$V_{GE}$ = 0 V; I <sub>F</sub> = 10 A; T <sub>j</sub> = 150 °C		-	1.5	-	V
$V_{\text{GE(th)}}$	Gate-emitter threhold voltage	$I_{c}$ = 500 uA; $V_{ce}$ = $V_{ge}$		4	5	6	V
I <sub>CES</sub>	Zero gate voltage collector	$V_{ce}$ = 650 V; $V_{ge}$ = 0 V; $T_j$ = 25 °C		-	-	100	uA
	current	$V_{CE}$ = 650 V; $V_{GE}$ = 0 V; $T_{j}$ = 150 °C		-	-	1	mA
$g_{fs}$	Transconductance	$V_{ce}$ = 20 V; I <sub>c</sub> = 50 A		-	60	-	S
Dynamic	characteristics						
C <sub>ies</sub>	Input capacitance	$V_{CE}$ = 30 V; $V_{GE}$ = 0V; f = 1 MHz;		-	5571	-	pF
C <sub>oes</sub>	Output capacitance	T <sub>j</sub> = 25 °C		-	92	-	pF
C <sub>res</sub>	Reverse transfer capacitance			-	65	-	pF
Q <sub>G</sub>	Gate charge	V <sub>cc</sub> = 520 V; I <sub>c</sub> = 50 A; V <sub>GE</sub> = 15 V; T <sub>i</sub> = 25 °C		-	237	-	nC

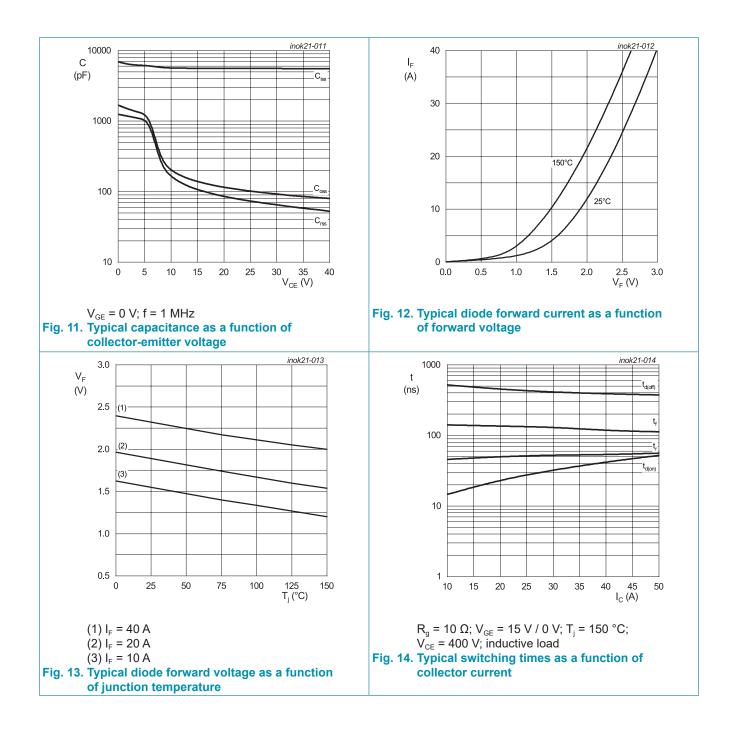
# **11. Switching Characteristics**

Table 8.	Switching	Characteristics,	Inductive Load
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Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
IGBT cha	racteristics				÷		
t <sub>d(on)</sub>	Turn-on delay time	T <sub>j</sub> = 25 °C;		-	58	-	nS
t <sub>r</sub>	Rise time	$V_{cc} = 400 \text{ V}; \text{ I}_{c} = 50 \text{ A}; \text{ V}_{GE} = 15 \text{ V} / 0 \text{ V};$ R <sub>G</sub> = 10 ohm		-	52	-	nS
$t_{\rm d(off)}$	Turn-off delay time			-	336	-	nS
t <sub>f</sub>	Fall time			-	74	-	nS
Eon	Turn-on energy			-	1.69	-	mJ
E <sub>off</sub>	Turn-off energy			-	1.24	-	mJ
E <sub>ts</sub>	Total switching energy			-	2.93	-	mJ
t <sub>d(on)</sub>	Turn-on delay time	T <sub>j</sub> = 150 °C;		-	56	-	nS
t <sub>r</sub>	Rise time	V <sub>cc</sub> = 400 V; I <sub>c</sub> = 50 A; V <sub>GE</sub> = 15V / 0V; R <sub>G</sub> = 10 ohm		-	52	-	nS
$t_{\rm d(off)}$	Turn-off delay time			-	372	-	nS
t <sub>f</sub>	Fall time			-	112	-	nS
E <sub>on</sub>	Turn-on energy			-	2.29	-	mJ
E <sub>off</sub>	Turn-off energy			-	1.69	-	mJ
E <sub>ts</sub>	Total switching energy			-	3.98	-	mJ
Diode cha	racteristics	·					_
t <sub>rr</sub>	Reverse recovery time	$T_j = 25 °C;$		-	65	-	nS
Q <sub>r</sub>	Reverse recovery charge	$V_{R} = 400 \text{ V}; \text{ I}_{F} = 10 \text{ A}; \text{ dI}_{F}/\text{dt} = 500 \text{ A}/\text{us}$		-	585	-	nC
I <sub>RM</sub>	Reverse recovery peak current			-	16	-	A
t <sub>rr</sub>	Reverse recovery time	T <sub>j</sub> = 150 °C;		-	100	-	nS
Q <sub>r</sub>	Reverse recovery charge	$V_{R} = 400 \text{ V}; \text{ I}_{F} = 10 \text{ A}; \text{ dI}_{F}/\text{dt} = 500 \text{ A}/\text{us}$		-	1240	-	nC
I <sub>RM</sub>	Reverse recovery peak current			-	22	-	А

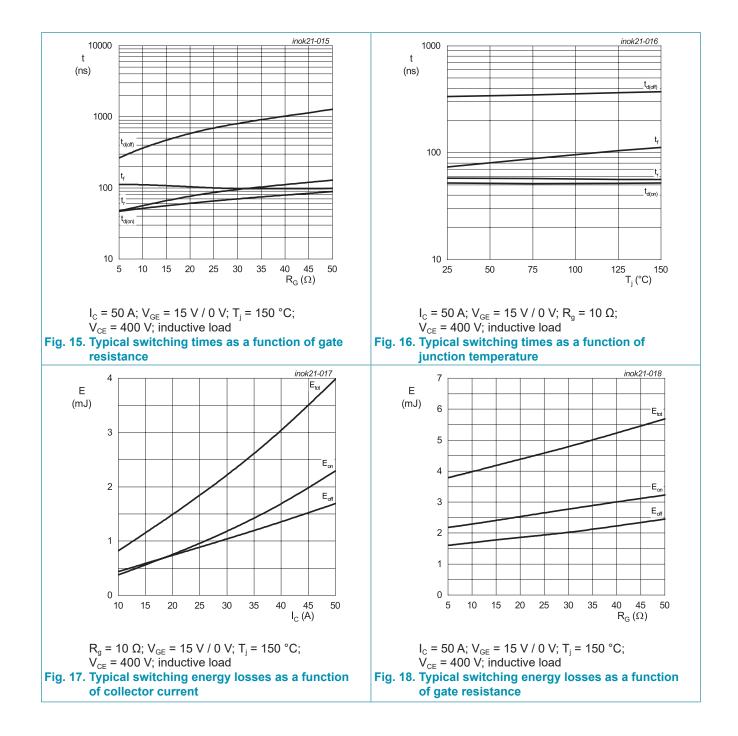


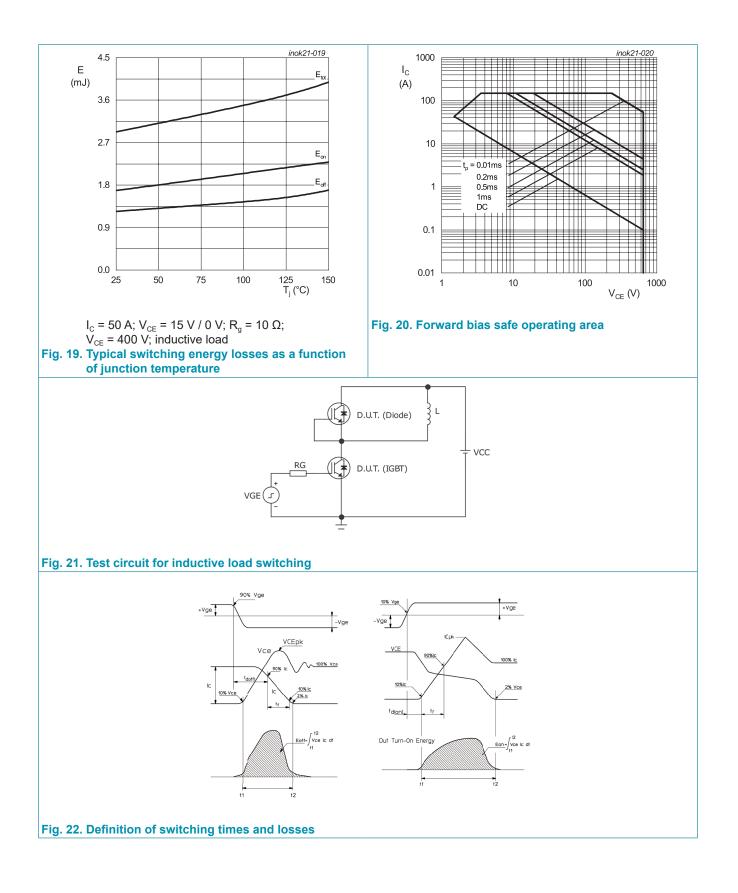




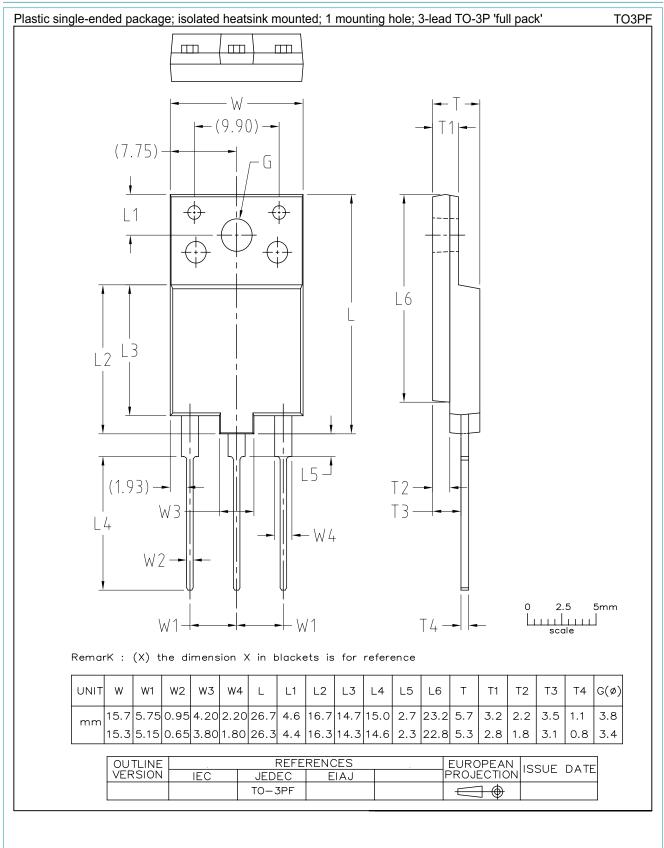
#### **WeEn Semiconductors**

WG50N65DHJ1





### 12. Package outline



# 13. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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